Digital fringe projection (DFP) techniques are used for non-contact shape measurement of 3D images. In the rapidly expanding field of 3D high-speed imaging, the demand for DFP continues to grow due to the technology's fast speed, flexibility, low cost, and high accuracy. High-Speed 3D Imaging with Digital Fringe Projection Techniques discusses the generation of digital fringe with digital video projection devices, covering a variety of core technical aspects. The book begins by establishing the theoretical foundations of fringe pattern analysis, reviewing various 3D imaging techniques while highlighting the advantages of DFP. The author then: Describes the differences between digital light processing (DLP), liquid crystal display (LCD), and liquid crystal on silicon (LCoS) Explains how to unwrap phase maps temporally and spatially Shows how to generate fringe patterns with video projectors Demonstrates how to convert phase to coordinates through system calibrations Provides a detailed example of a built-from-scratch 3D imaging system Incorporating valuable insights gained during the author’s 15+ years of 3D imaging research, High-Speed 3D Imaging with Digital Fringe Projection Techniques illuminates the pathway to advancement in high-speed 3D optical imaging using DFP.

"E-health is closely related with networks and telecommunications when dealing with applications of collecting or transferring medical data from distant locations for performing remote medical collaborations and diagnosis. In this book we provide an overview of the fields of image and signal processing for networked and distributed e-health applications and their supporting technologies. The book is structured in 10 chapters, starting the discussion from the lower end, that of acquisition and processing of biosignals and medical images and ending in complex virtual reality systems and techniques providing more intuitive interaction in a networked medical environment. The book also discusses networked clinical decision support systems and corresponding medical standards, WWW-based applications, medical collaborative platforms, wireless networking, and the concepts of ambient intelligence and pervasive computing in electronic healthcare systems."--Publishers' Website.

A methodology for using domino logic in an ASIC design flow for graduate students, researchers, and circuit designers in industry.

High-Speed Clock Network Design is a collection of design concepts, techniques and research works from the author for clock distribution in microprocessors and high-performance chips. It is organized in 11 chapters.

Modern communications technology demands smaller, faster and more efficient circuits. This book reviews the fundamentals of electromagnetism in passive and active circuit elements, highlighting various effects and potential problems in designing a new circuit. The author begins with a review of the basics - the origin of resistance, capacitance, and inductance - then progresses to more advanced topics such as passive device design and layout, resonant circuits, impedance matching, high-speed switching circuits, and parasitic coupling and isolation techniques. Using examples and applications in RF and microwave systems, the author describes transmission lines, transformers, and distributed circuits. State-of-the-art developments in Si based broadband analog, RF, microwave, and mm-wave circuits are reviewed. With up-to-
date results, techniques, practical examples, illustrations and worked examples, this book will be valuable to advanced undergraduate and graduate students of electrical engineering, and practitioners in the IC design industry. Further resources for this title are available at www.cambridge.org/9780521853507.

Complete PCB Design Using OrCad Capture and Layout provides instruction on how to use the OrCad design suite to design and manufacture printed circuit boards. The book is written for both students and practicing engineers who need a quick tutorial on how to use the software and who need in-depth knowledge of the capabilities and limitations of the software package. There are two goals the book aims to reach: The primary goal is to show the reader how to design a PCB using OrCAD Capture and OrCAD Layout. Capture is used to build the schematic diagram of the circuit, and Layout is used to design the circuit board so that it can be manufactured. The secondary goal is to show the reader how to add PSpice simulation capabilities to the design, and how to develop custom schematic parts, footprints and PSpice models. Often times separate designs are produced for documentation, simulation and board fabrication. This book shows how to perform all three functions from the same schematic design. This approach saves time and money and ensures continuity between the design and the manufactured product. Information is presented in the exact order a circuit and PCB are designed Straightforward, realistic examples present the how and why the designs work, providing a comprehensive toolset for understanding the OrCAD software. Introduction to the IPC, JEDEC, and IEEE standards relating to PCB design. Full-color interior and extensive illustrations allow readers to learn features of the product in the most realistic manner possible.

A cutting-edge guide to the theory and practice of high-speed digital system design. An understanding of high-speed interconnect phenomena is essential for digital designers who must deal with the challenges posed by the ever-increasing operating speeds of today's microprocessors. This book provides a much-needed, practical guide to the state of the art of modern digital system design, combining easily accessible explanations with immensely useful problem-solving strategies. Written by three leading Intel engineers, High-Speed Digital System Design clarifies difficult and often neglected topics involving the effects of high frequencies on digital buses and presents a variety of proven techniques and application examples. Extensive appendices, formulas, modeling techniques as well as hundreds of figures are also provided. Coverage includes: * A thorough introduction to the digital aspects of basic transmission line theory * Crosstalk and nonideal transmission line effects on signal quality and timings * The impact of packages, vias, and connectors on signal integrity * The effects of nonideal return current paths, high frequency power delivery, and simultaneous switching noise * Explanations of how driving circuit characteristics affect the quality of the digital signal * Digital timing analysis at the system level that incorporates high-speed signaling effects into timing budgets * Methodologies for designing high-speed buses and handling the very large number of variables that affect interconnect performance * Radiated emission problems and how to minimize system noise * The practical aspects of making measurements in high-speed digital systems.

A transistor-level, design-intensive overview of high speed and high frequency monolithic integrated circuits for wireless and broadband systems from 2 GHz to 200 GHz, this comprehensive text covers high-speed, RF, mm-wave, and optical fibre applications.
circuits using nanoscale CMOS, SiGe BiCMOS, and III-V technologies. Step-by-step design methodologies, end-of-chapter problems, and practical simulation and design projects are provided, making this an ideal resource for senior undergraduate and graduate courses in circuit design. With an emphasis on device-circuit topology interaction and optimization, it gives circuit designers and students alike an in-depth understanding of device structures and process limitations affecting circuit performance.

This lecture provides an introduction to transmission line effects in the time domain. Fundamentals including time of flight, impedance discontinuities, proper termination schemes, nonlinear and reactive loads, and crosstalk are considered. Required prerequisite knowledge is limited to conventional circuit theory. The material is intended to supplement standard textbooks for use with undergraduate students in electrical engineering or computer engineering. The contents should also be of value to practicing engineers with interests in signal integrity and high-speed digital design.


High-speed Digital Design: A Handbook of Black Magic

New System-Level Techniques for Optimizing Signal/Power Integrity in High-Speed Interfaces--from Pioneering Innovators at Rambus, Stanford, Berkeley, and MIT As data communication rates accelerate well into the multi-gigahertz range, ensuring signal integrity both on- and off-chip has become crucial. Signal integrity can no longer be addressed solely through improvements in package or board-level design: Diverse engineering teams must work together closely from the earliest design stages to identify the best system-level solutions. In High-Speed Signaling, several of the field’s most respected practitioners and researchers introduce cutting-edge modeling, simulation, and optimization techniques for meeting this challenge. Edited by pioneering experts Drs. Dan Oh and Chuck Yuan, these contributors explain why noise and jitter are no longer separable, demonstrate how to model their increasingly complex interactions, and thoroughly introduce a new simulation methodology for predicting link-level performance with unprecedented accuracy. The authors address signal integrity from architecture through high-volume production, thoroughly discussing design, implementation, and verification. Coverage includes New advances in passive-channel modeling, power-supply noise and jitter modeling, and system margin prediction Methodologies for balancing system voltage and timing budgets to improve system robustness in high-volume manufacturing Practical, stable formulae for converting key network parameters Improved solutions for difficult problems in the broadband modeling of interconnects Equalization techniques for optimizing channel performance Important new insights into the relationships between jitter and clocking topologies New on-chip measurement techniques for in-situ link performance testing Trends and future directions in signal integrity engineering High-Speed Signaling thoroughly introduces new techniques pioneered at Rambus and other leading high-tech companies and universities: approaches that have never before been presented with this much
practical detail. It will be invaluable to everyone concerned with signal integrity, including signal and power integrity engineers, high-speed I/O circuit designers, and system-level board design engineers.

Consistently Design PDNs That Deliver Reliable Performance at the Right Cost Too often, PDN designs work inconsistently, and techniques that work in some scenarios seem to fail inexplicably in others. This book explains why and presents realistic processes for getting PDN designs right in any new product. Drawing on 60+ years of signal and power integrity experience, Larry Smith and Eric Bogatin show how to manage noise and electrical performance, and complement intuition with analysis to balance cost, performance, risk, and schedule. Throughout, they distill the essence of complex real-world problems, quantify core principles via approximation, and apply them to specific examples. For easy usage, dozens of key concepts and observations are highlighted as tips and listed in quick, chapter-ending summaries. Coverage includes: • A practical, start-to-finish approach to consistently meeting PDN performance goals • Understanding how signals interact with interconnects • Identifying root causes of common problems, so you can avoid them • Leveraging analysis tools to efficiently explore design space and optimize tradeoffs • Analyzing impedance-related properties of series and parallel RLC circuits • Measuring low impedance for components and entire PDN ecologies • Predicting loop inductance from physical design features • Reducing peak impedances from combinations of capacitors • Understanding power and ground plane properties in the PDN interconnect • Taming signal integrity problems when signals change return planes • Reducing peak impedance created by on-die capacitance and package lead inductance • Controlling transient current waveform interactions with PDN features • Simple spreadsheet-based analysis techniques for quickly creating first-pass designs This guide will be indispensable for all engineers involved in PDN design, including product, board, and chip designers; system, hardware, component, and package engineers; power supply designers, SI and EMI engineers, sales engineers, and their managers.

High-Speed Signal Propagation: Advanced Black Magic brings together state-of-the-art techniques for building digital devices that can transmit faster and farther than ever before. Dr. Howard Johnson presents brand-new examples and design guidance, and a complete, unified theory of signal propagation for all metallic media. Coverage includes: understanding signal impairments; managing speed/distance tradeoffs; differential signaling; inter-cabinet connections; clock distribution; simulation, and much more. State-of-the-art JNB and SI Problem-Solving: Theory, Analysis, Methods, and Applications Jitter, noise, and bit error (JNB) and signal integrity (SI) have become today’s greatest challenges in high-speed digital design. Now, there’s a comprehensive and up-to-date guide to overcoming these challenges, direct from Dr. Mike Peng Li, cochair of the PCI Express jitter standard committee. One of the field’s most respected experts, Li has brought together the latest theory, analysis, methods, and practical applications, demonstrating how to solve difficult JNB and SI problems in both link components and complete systems. Li introduces the fundamental terminology, definitions, and concepts associated with JNB and SI, as well as their sources and root causes. He guides readers from basic math, statistics, circuit and system models all the way through final applications. Emphasizing clock and serial data communications applications, he covers JNB and SI simulation, modeling, diagnostics,
debugging, compliance testing, and much more. This leading-edge circuit design resource offers the knowledge needed to quickly pinpoint transmission problems that can compromise circuit design. Discusses both design and debug issues at gigabit per second data rates. This Second Edition focuses on emerging topics and advances in the field of VLSI interconnections. In the decade since High-Speed VLSI Interconnections was first published, several major developments have taken place in the field. Now, updated to reflect these advancements, this Second Edition includes new information on copper interconnections, nanotechnology circuit interconnects, electromigration in the copper interconnections, parasitic inductances, and RLC models for comprehensive analysis of interconnection delays and crosstalk. Each chapter is designed to exist independently or as a part of one coherent unit, and several appropriate exercises are provided at the end of each chapter, challenging the reader to gain further insight into the contents being discussed. Chapter subjects include: Preliminary Concepts, Parasitic Resistances, Capacitances, and Inductances, Interconnection Delays, Crosstalk Analysis, Electromigration-Induced Failure Analysis, Future Interconnections. High-Speed VLSI Interconnections, Second Edition is an indispensable reference for high-speed VLSI designers, RF circuit designers, and advanced students of electrical engineering.

The Circuit Designer's Companion covers the theoretical aspects and practices in analogue and digital circuit design. Electronic circuit design involves designing a circuit that will fulfill its specified function and designing the same circuit so that every production model of it will fulfill its specified function, and no other undesired and unspecified function. This book is composed of nine chapters and starts with a review of the concept of grounding, wiring, and printed circuits. The subsequent chapters deal with the passive and active components of circuitry design. These topics are followed by discussions of the principles of other design components, including linear integrated circuits, digital circuits, and power supplies. The remaining chapters consider the vital role of electromagnetic compatibility in circuit design. These chapters also look into safety, design of production, testability, reliability, and thermal management of the designed circuit. This book is of great value to electrical and design engineers.

Offset Reduction Techniques in High-Speed Analog-to-Digital Converters analyzes, describes the design, and presents test results of Analog-to-Digital Converters (ADCs) employing the three main high-speed architectures: flash, two-step flash and folding and interpolation. The advantages and limitations of each one are reviewed, and the techniques employed to improve their performance are discussed. Written by the world's most prominent microprocessor design leaders from industry and academia, this book provides complete coverage of all aspects of complex microprocessor design: technology, power management, clocking, high-performance architecture, design methodologies, memory and I/O design, computer aided design, testing and design for testability. The chapters provide state-of-the-art knowledge while including sufficient tutorial material to bring non-
experts up to speed. A useful companion to design engineers working in related areas.
This book covers the theory and applications of high-speed analog-to-digital conversion. An analog-to-digital converter takes real-world inputs (such as visual images, temperature readings, and rates of speed) and transforms them into digital form for processing by computer. This book discusses the design and uses of such circuits, with particular emphasis on improving the speed of the conversion process and the accuracy of its output—how well the output is a corresponding digital representation of the input signal. As computers become increasingly interfaced to the outside world, "ADC" techniques will become ever more important.

A synergistic approach to signal integrity for high-speed digital design This book is designed to provide contemporary readers with an understanding of the emerging high-speed signal integrity issues that are creating roadblocks in digital design. Written by the foremost experts on the subject, it leverages concepts and techniques from non-related fields such as applied physics and microwave engineering and applies them to high-speed digital design—creating the optimal combination between theory and practical applications. Following an introduction to the importance of signal integrity, chapter coverage includes: Electromagnetic fundamentals for signal integrity Transmission line fundamentals Crosstalk Non-ideal conductor models, including surface roughness and frequency-dependent inductance Frequency-dependent properties of dielectrics Differential signaling Mathematical requirements of physical channels S-parameters for digital engineers Non-ideal return paths and via resonance I/O circuits and models Equalization Modeling and budgeting of timing jitter and noise System analysis using response surface modeling Each chapter includes many figures and numerous examples to help readers relate the concepts to everyday design and concludes with problems for readers to test their understanding of the material.

Advanced Signal Integrity for High-Speed Digital Designs is suitable as a textbook for graduate-level courses on signal integrity, for programs taught in industry for professional engineers, and as a reference for the high-speed digital designer.

High-Speed DSP and Analog System Design is based on the author’s over 25 years of experience in high-speed DSP and computer systems and courses in both digital and analog systems design at Rice University. It provides hands-on, practical advice for working engineers, including: • Tips on cost-efficient design and system simulation that minimize late-stage redesign costs and product shipment delays • Emphasis on good high-speed and analog design practices that minimize both component and system noise and ensure system design success. • Guidelines to be used throughout the design process to reduce noise and radiation and to avoid common pitfalls while improve quality and reliability. • Hand-on design examples focusing on audio, video, analog filters, DDR memory, and power supplies. The inclusion of analog systems and related issues cannot
be found in other high-speed design books. “This book is an essential resource for all engineers either interested in or working on system designs. It was created by a recognized system design expert who not only teaches these principles daily but who brings years of hands on design expertise as the creator of some of the personal computer industries’ most differentiated audio solutions” —Jim Ganthier, Vice President of Marketing and Solutions, Industry Standard Servers-Hewlett-Packard “This book helps designers by highlighting the pitfalls of high-speed systems design and providing solutions that improve the probability of success. Investing a small amount of time in the use of low-noise and low-radiation design methods from the very beginning of the development cycle will generate a high payoff by minimizing late-stage redesign costs and delays in the product ship date. To improve the probability of design success, applying the rules outlined in this book is a must-do.”—Gene Frantz, Principle Fellow, Texas Instruments Incorporated. High-Speed DSP and Analog System Design is appropriate for advanced undergraduate and graduate students, researchers and professionals in signal processing and system design.

This book describes for readers the entire, interconnected complex of theoretical and practical aspects of designing and organizing the production of various electronic devices, the general and main distinguishing feature of which is the high speed of processing and transmitting of digital signals. The authors discuss all the main stages of design - from the upper system level of the hierarchy (telecommunications system, 5G mobile communications) to the lower level of basic semiconductor elements, printed circuit boards. Since the developers of these devices in practice deal with distorted digital signals that are transmitted against a background of interference, the authors not only explain the physical nature of such effects, but also offer specific solutions as to how to avoid such parasitic effects, even at the design stage of high-speed devices.

What makes some computers slow? Why do some digital systems operate reliably for years while others fail mysteriously every few hours? How can some systems dissipate kilowatts while others operate off batteries? These questions of speed, reliability, and power are all determined by the system-level electrical design of a digital system. Digital Systems Engineering presents a comprehensive treatment of these topics. It combines a rigorous development of the fundamental principles in each area with real-world examples of circuits and methods. The book not only serves as an undergraduate textbook, filling the gap between circuit design and logic design, but can also help practising digital designers keep pace with the speed and power of modern integrated circuits. The techniques described in this book, once used only in supercomputers, are essential to the correct and efficient operation of any type of digital system. High Speed Digital Design discusses the major factors to consider in designing a high speed digital system and how design concepts affect the functionality of the system as a whole. It will help you understand why signals act so differently on a high speed digital system, identify the various problems that may occur in the
design, and research solutions to minimize their impact and address their root causes. The authors offer a strong foundation that will help you get high speed digital system designs right the first time. Taking a systems design approach, High Speed Digital Design offers a progression from fundamental to advanced concepts, starting with transmission line theory, covering core concepts as well as recent developments. It then covers the challenges of signal and power integrity, offers guidelines for channel modeling, and optimizing link circuits. Tying together concepts presented throughout the book, the authors present Intel processors and chipsets as real-world design examples. Provides knowledge and guidance in the design of high speed digital circuits Explores the latest developments in system design Covers everything that encompasses a successful printed circuit board (PCB) product Offers insight from Intel insiders about real-world high speed digital design

Digital circuit technology is the future of the telecommunications, semiconductor, and network industries. It is essential for engineers involved in VLSI and integrated circuit design to become informed of this emerging technology. This book covers all facets of the technology, from basic theories of physics to a practical guide for designing and implementing digital circuits.

This book contains the extended and revised editions of all the talks of the ninth AACD Workshop held in Hotel Bachmair, April 11 - 13 2000 in Rottach-Egem, Germany. The local organization was managed by Rudolf Koch of Infineon Technologies AG, Munich, Germany. The program consisted of six tutorials per day during three days. Experts in the field presented these tutorials and state of the art information is communicated. The audience at the end of the workshop selects program topics for the following workshop. The program committee, consisting of Johan Huijsing of Delft University of Technology, Willy Sansen of Katholieke Universiteit Leuven and Rudy van de Plassche of Broadcom Netherlands BV Bunnik elaborates the selected topics into a three-day program and selects experts in the field for presentation. Each AACD Workshop has given rise to publication of a book by Kluwer entitled "Analog Circuit Design". A series of nine books in a row provides valuable information and good overviews of all analog circuit techniques concerning design, CAD, simulation and device modeling. These books can be seen as a reference to those people involved in analog and mixed signal design. The aim of the workshop is to brainstorm on new and valuable design ideas in the area of analog circuit design. It is the hope of the program committee that this ninth book continues the tradition of emerging contributions to the design of analog and mixed signal systems in Europe and the rest of the world.

High speed data converters represent one of the most challenging, important and exciting analog and mixed-signal systems. They are ubiquitous in our modern and highly connected world. Understanding and designing this class of converters require proficiency in analog circuit design, digital design, and signal processing. This book covers high speed data converters from the perspective of
a leading high speed ADC designer and architect, and with a strong emphasis on high speed Nyquist A/D converters. Topics covered include an introduction to high-speed data conversion; performance metrics; data converter architectures; sampling; comparators; amplifiers; pipelined A/D converters; time-interleaved converters; digitally assisted converters; evolution and trends. The book is intended for engineers and students who design, evaluate or use high speed data converters. A basic foundation in circuits, devices and signal processing is required. The book is meant to bridge the gap between analysis and design, theory and practice, circuits and systems. It covers basic analog circuits and digital signal processing algorithms. There is a healthy dose of theoretical analysis in this book, combined with the practical issues and intuitive perspectives.

In response to tremendous growth and new technologies in the semiconductor industry, this volume is organized into five, information-rich sections. Digital Design and Fabrication surveys the latest advances in computer architecture and design as well as the technologies used to manufacture and test them. Featuring contributions from leading experts, the book also includes a new section on memory and storage in addition to a new chapter on nonvolatile memory technologies. Developing advanced concepts, this sharply focused book—

Describes new technologies that have become driving factors for the electronic industry
Includes new information on semiconductor memory circuits, whose development best illustrates the phenomenal progress encountered by the fabrication and technology sector
Contains a section dedicated to issues related to system power consumption
Describes reliability and testability of computer systems
Pinpoints trends and state-of-the-art advances in fabrication and CMOS technologies
Describes performance evaluation measures, which are the bottom line from the user's point of view
Discusses design techniques used to create modern computer systems, including high-speed computer arithmetic and high-frequency design, timing and clocking, and PLL and DLL design

Personal computer data rates have already climbed into the multi-Gigahertz frequency range that requires microwave design techniques for interconnect circuitry. Have your design skills kept pace? Most digital designers were trained in an era when you could use idealized models to simplify circuitry design. The very high speeds demanded for today's computers negate the benefits and applicability of those idealizations, thereby threatening a generation of designers with obsolescence. Microwave design uses a new vocabulary; both the words and the concepts are often unfamiliar to digital designers. This book provides sorely needed information that is both appropriate to the 21st century PC industry and explained in terms digital designers understand. Written for the experienced engineer who is responsible for signal integrity, Designing High-Speed Interconnect Circuits provides you with the skills to cope with high-speed technologies, such as PCI Express. This introduction to the properties, mathematics, and methods helps you understand the concepts behind the
buzzwords and bootstrap yourself into the world of microwave frequency circuit design.

This book provides instruction on how to use the OrCAD design suite to design and manufacture printed circuit boards. The primary goal is to show the reader how to design a PCB using OrCAD Capture and OrCAD Editor. Capture is used to build the schematic diagram of the circuit, and Editor is used to design the circuit board so that it can be manufactured. The book is written for both students and practicing engineers who need in-depth instruction on how to use the software, and who need background knowledge of the PCB design process. Beginning to end coverage of the printed circuit board design process. Information is presented in the exact order a circuit and PCB are designed. Over 400 full color illustrations, including extensive use of screen shots from the software, allow readers to learn features of the product in the most realistic manner possible. Straightforward, realistic examples present the how and why the designs work, providing a comprehensive toolset for understanding the OrCAD software. Introduces and follows IEEE, IPC, and JEDEC industry standards for PCB design. Unique chapter on Design for Manufacture covers padstack and footprint design, and component placement, for the design of manufacturable PCB’s. FREE CD containing the OrCAD demo version and design files.

The #1 guide to signal integrity, updated with all-new coverage of power integrity, high-speed serial links, and more. * * Up-to-the-minute comprehensive guidance: everything engineers need to know to understand and design for signal integrity. * Authored by world-renowned signal integrity trainer, educator, and columnist Eric Bogatin. * Focuses on intuitive understanding, practical tools, and engineering discipline - not theoretical derivation or mathematical rigor. Today’s marketplace demands faster devices and systems that deliver more functionality and longer life in smaller packaging. Signal Integrity - Simplified, Second Edition is the first book to bring together all the up-to-the-minute techniques designers need to overcome all of those challenges. Renowned expert Eric Bogatin thoroughly reviews the root causes of all four families of signal integrity problems, and shows how to design them out early in the design cycle. Drawing on his experience teaching 5,000+ engineers, he illuminates signal integrity, physical design, bandwidth, inductance, and impedance; presents practical tools for solving signal integrity problems; and offers specific design guidelines and solutions. In this edition, Bogatin adds extensive coverage of power integrity and high-speed serial links: topics at the forefront of signal integrity design. Three new chapters address: * * Designing power delivery networks to support high-speed signal processing. * Using 4-Port S-parameters, the emerging standard for describing interconnects in high-speed serial links. * Working with today’s measurement and simulation tools and technologies

Before putting digital systems for information technology or telecommunication applications on the market, an essential requirement is to perform tests in order to comply with the limits of radiated emission imposed by the standards. This book provides an investigation into signal...
integrity (SI) and electromagnetic interference (EMI) problems. Topics such as reflections, crosstalk, switching noise and radiated emission (RE) in high-speed digital systems are covered, which are essential for IT and telecoms applications. The highly important topic of modelling is covered which can reduce costs by enabling simulation data to demonstrate that a product meets design specifications and regulatory limits. According to the new European EMC directive, this can help to avoid the expensive use of large semi-anechoic chambers or open area test sites for radiated emission assessments. Following a short introduction to signalling and radiated interference in digital systems, the book provides a detailed characterization of logic families in terms of static and dynamic characteristic useful for modelling techniques. Crosstalk in multi-coupled line structures are investigated by analytical, graphical and circuit-based methods, and techniques to mitigate these phenomena are provided. Grounding, filtering and shielding with multilayer PCBs are also examined and design rules given. Written by authors with extensive experience in industry and academia. Explains basic conceptual problems from a theoretical and practical point of view by using numerous measurements and simulations. Presents models for mathematical and SPICE-like circuit simulators. Provides examples of using full-wave codes for SI and RE investigations. Companion website containing lists of codes and sample material. Signal Integrity and Radiated Emission of High-Speed Digital Systems is a valuable resource to industrial designers of information technology, telecommunication equipment and automation equipment as well as to development engineers. It will also be of interest to managers and designers of consumer electronics, and researchers in electronics. Modeling and Design of Electromagnetic Compatibility for High-Speed Printed Circuit Boards and Packaging presents the electromagnetic modelling and design of three major electromagnetic compatibility (EMC) issues related to the high-speed printed circuit board (PCB) and electronic packages: signal integrity (SI), power integrity (PI), and electromagnetic interference (EMI). The emphasis is put on two essential passive components of PCBs and packages: the power distribution network and the signal distribution network. This book includes two parts. Part one talks about the field-circuit hybrid methods used for the EMC modeling, including the modal method, the integral equation method, the cylindrical wave expansion method and the de-embedding method. Part two illustrates EMC design methods and explores the applications of novel metamaterials and two-dimensional materials on traditional EMC problems. This book is designed to enhance worthwhile electromagnetic theory and mathematical methods for practical engineers and to train students with advanced EMC applications. High-speed, power-efficient analog integrated circuits can be used as standalone devices or to interface modern digital signal processors and micro-controllers in various applications, including multimedia, communication, instrumentation, and control systems. New architectures and low device geometry of complementary metaloxidesemiconductor (CMOS) technologies have accelerated the movement toward system on a chip design, which merges analog circuits with digital, and radio-frequency components. Focused on the field of knowledge lying between digital and analog circuit theory, this new text will help engineers working with digital systems shorten their product development cycles and help fix their latest design problems. The scope of the material covered includes signal reflection, crosstalk, and noise problems which occur in high speed digital machines (above 10 megahertz). This volume will be of practical use to digital logic designers, staff and senior communications scientists, and all those interested in digital design. Engineering Digital Design, Second Edition provides the most extensive coverage of any available textbook in digital logic and design. The new REVISED Second Edition published in September of 2002 provides 5 productivity tools free on the accompanying CD ROM. This software is also included on the Instructor's Manual CD ROM and complete instructions
accompany each software program. In the REVISED Second Edition modern notation combines with state-of-the-art treatment of the most important subjects in digital design to provide the student with the background needed to enter industry or graduate study at a competitive level. Combinatorial logic design and synchronous and asynchronous sequential machine design methods are given equal weight, and new ideas and design approaches are explored. The productivity tools provided on the accompanying CD are outlined below: [1] EXL-Sim2002 logic simulator: EXL-Sim2002 is a full-featured, interactive, schematic-capture and simulation program that is ideally suited for use with the text at either the entry or advanced-level of logic design. Its many features include drag-and-drop capability, rubber banding, mixed logic and positive logic simulations, macro generation, individual and global (or randomized) delay assignments, connection features that eliminate the need for wire connections, schematic page sizing and zooming, waveform zooming and scrolling, a variety of printout capabilities, and a host of other useful features. [2] BOOZER logic minimizer: BOOZER is a software minimization tool that is recommended for use with the text. It accepts entered variable (EV) or canonical (1's and 0's) data from K-maps or truth tables, with or without don't cares, and returns an optimal or near optimal single or multi-output solution. It can handle up to 12 functions Boolean functions and as many inputs when used on modern computers. [3] ESPRESSO II logic minimizer: ESPRESSO II is another software minimization tool widely used in schools and industry. It supports advanced heuristic algorithms for minimization of two-level, multi-output Boolean functions but does not accept entered variables. It is also readily available from the University of California, Berkeley, 1986 VLSI Tools Distribution. [4] ADAM design software: ADAM (for Automated Design of Asynchronous Machines) is a very powerful productivity tool that permits the automated design of very complex asynchronous state machines, all free of timing defects. The input files are state tables for the desired state machines. The output files are given in the Berkeley format appropriate for directly programming PLAs. ADAM also allows the designer to design synchronous state machines, timing-defect-free. The options include the lumped path delay (LPD) model or NESTED CELL model for asynchronous FSM designs, and the use of D FLIP-FLOPs for synchronous FSM designs. The background for the use of ADAM is covered in Chapters 11, 14 and 16 of the REVISED 2nd Edition. [5] A-OPS design software: A-OPS (for Asynchronous One-hot Programmable Sequencers) is another very powerful productivity tool that permits the design of asynchronous and synchronous state machines by using a programmable sequencer kernel. This software generates a PLA or PAL output file (in Berkeley format) or the VHDL code for the automated timing-defect-free designs of the following: (a) Any 1-Hot programmable sequencer up to 10 states. (b) The 1-Hot design of multiple asynchronous or synchronous state machines driven by either PLDs or RAM. The input file is that of a state table for the desired state machine. This software can be used to design systems with the capability of instantly switching between several radically different controllers on a time-shared basis. The background for the use of A-OPS is covered in Chapters 13, 14 and 16 of the REVISED 2nd Edition. An essential guide to the background, design, and application of common-mode filtering structures in modern high-speed differential communication links Written by a team of experts in the field, Electromagnetic Bandgap (EBG) Structures explores the practical electromagnetic bandgap based common mode filters for power integrity applications and covers the theoretical and practical design approaches for common mode filtering in high-speed printed circuit boards, especially for boards in high data-rate systems. The authors describe the classic applications of electromagnetic bandgap (EBG) structures and the phenomena of common mode generation in high speed digital boards. The text also explores the fundamental electromagnetic mechanisms of the functioning of planar EBGs and considers the impact of planar EBGs on the digital signal propagation of single ended and differential interconnects routed on top or between EBGs. The authors examine the concept, design, and modeling of
EBG common mode filters in their two forms: on-board and removable. They also provide several comparisons between measurement and electromagnetic simulations that validate the proposed EBG filters' design approach. This important resource: • Presents information on planar EBG based common mode filters for high speed differential digital systems • Provides systematic analysis of the fundamental mechanisms of planar EBG structures • Offers detailed design methodology to create EBG filters without the need for repeated full-wave electromagnetic analysis • Demonstrates techniques for use in practical real-world designs

Electromagnetic Bandgap (EBG) Structures: Common Mode Filters for High Speed Digital Systems offers an introduction to the background, design, and application of common-mode filtering structures in modern high-speed differential communication links, a critical issue in high-speed and high-performance systems.

A modern, comprehensive introduction to DRAM for students and practicing chip designers Dynamic Random Access Memory (DRAM) technology has been one of the greatest driving forces in the advancement of solid-state technology. With its ability to produce high product volumes and low pricing, it forces solid-state memory manufacturers to work aggressively to cut costs while maintaining, if not increasing, their market share. As a result, the state of the art continues to advance owing to the tremendous pressure to get more memory chips from each silicon wafer, primarily through process scaling and clever design. From a team of engineers working in memory circuit design, DRAM Circuit Design gives students and practicing chip designers an easy-to-follow, yet thorough, introductory treatment of the subject. Focusing on the chip designer rather than the end user, this volume offers expanded, up-to-date coverage of DRAM circuit design by presenting both standard and high-speed implementations. Additionally, it explores a range of topics: the DRAM array, peripheral circuitry, global circuitry and considerations, voltage converters, synchronization in DRAMs, data path design, and power delivery. Additionally, this up-to-date and comprehensive book features topics in high-speed design and architecture and the ever-increasing speed requirements of memory circuits. The only book that covers the breadth and scope of the subject under one cover, DRAM Circuit Design is an invaluable introduction for students in courses on memory circuit design or advanced digital courses in VLSI or CMOS circuit design. It also serves as an essential, one-stop resource for academics, researchers, and practicing engineers.

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